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Kind regards,

Team Nexperia

NPN/PNP resistor-equipped transistors; R1 = 10 kΩ, R2 = 10 kΩ

Rev. 11 — 25 September 2013

**Product data sheet** 

#### **Product profile** 1.

### **1.1 General description**

NPN/PNP Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

#### Table 1. **Product overview**

Type number	Package			NPN/NPN	Package
	NXP	JEITA	complement	complement	configuration
PEMD3	SOT666	-	PEMB11	PEMH11	ultra small and flat lead
PIMD3	SOT457	SC-74	-	-	small
PUMD3	SOT363	SC-88	PUMB11	PUMH11	very small

Reduces pick and place costs

AEC-Q101 qualified

### **1.2 Features and benefits**

- 100 mA output current capability
   Reduces component count
- Built-in bias resistors
- Simplifies circuit design

### **1.3 Applications**

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

### 1.4 Quick reference data

Table 2.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor; for the PNP transistor	(TR2) with negative	ve polarity			
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	50	V
I <sub>O</sub>	output current		-	-	100	mA
R1	bias resistor 1 (input)		7	10	13	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	



**NPN/PNP** resistor-equipped transistors

3

2 006aaa143

1

#### **Pinning information** 2.

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	GND (emitter) TR1		
2	input (base) TR1	6 5 4	
3	output (collector) TR2		
4	GND (emitter) TR2		
5	input (base) TR2		
6	output (collector) TR1	001aab555	

#### **Ordering information** 3.

#### Table 4. **Ordering information**

Type number	ype number Package				
	Name	Description	Version		
PEMD3	-	plastic surface-mounted package; 6 leads	SOT666		
PIMD3	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457		
PUMD3	SC-88	plastic surface-mounted package; 6 leads	SOT363		

#### Marking 4.

#### Table 5. Marking codes

Type number	Marking code <sup>[1]</sup>
PEMD3	D3
PIMD3	M7
PUMD3	D*3

[1] \* = placeholder for manufacturing site code.

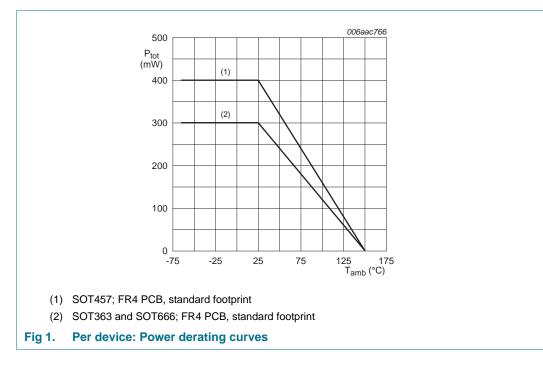
NPN/PNP resistor-equipped transistors

### 5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor; for the PNP transistor	(TR2) with negative	polarity		
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	10	V
VI	input voltage TR1				
	positive		-	+40	V
	negative		-	-10	V
	input voltage TR2				
	positive		-	+10	V
	negative		-	-40	V
lo	output current		-	100	mA
I <sub>CM</sub>	peak collector current		-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1]		
	PEMD3 (SOT666)		-	200	mW
	PIMD3 (SOT457)		-	250	mW
	PUMD3 (SOT363)		-	200	mW
Per device	)				
P <sub>tot</sub>	total power dissipation	$T_{amb} \leq 25 \ ^{\circ}C$	[1]		
	PEMD3 (SOT666)		-	300	mW
	PIMD3 (SOT457)		-	400	mW
	PUMD3 (SOT363)		-	300	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

NPN/PNP resistor-equipped transistors



### 6. Thermal characteristics

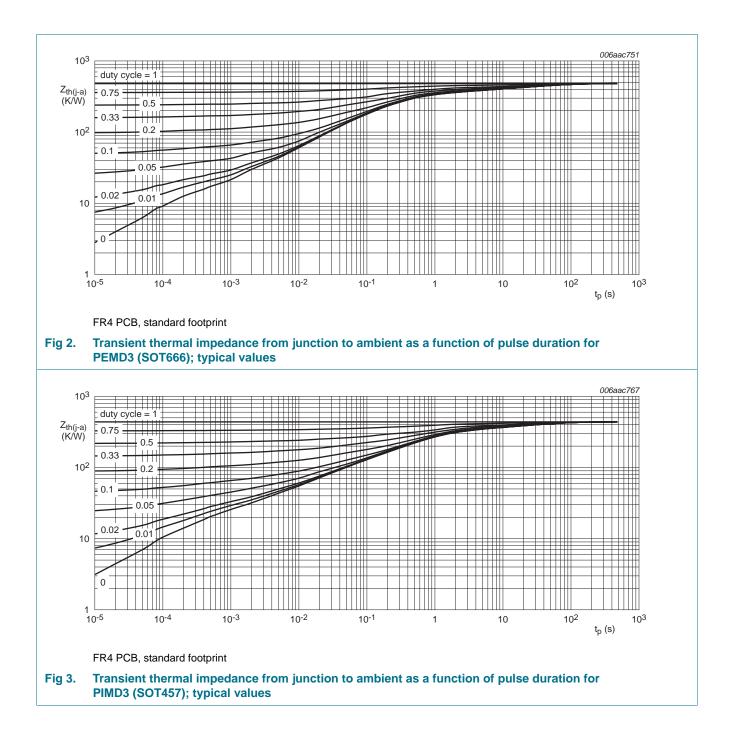
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	sistor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	PEMD3 (SOT666)		-	-	625	K/W
	PIMD3 (SOT457)		-	-	500	K/W
	PUMD3 (SOT363)		-	-	625	K/W
Per devi	ce					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	PEMD3 (SOT666)		-	-	417	K/W
	PIMD3 (SOT457)		-	-	313	K/W
	PUMD3 (SOT363)		-	-	417	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### **NXP Semiconductors**

### PEMD3; PIMD3; PUMD3

**NPN/PNP** resistor-equipped transistors

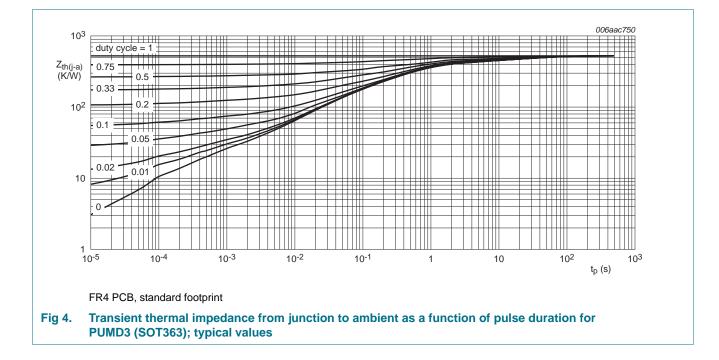


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#### **NXP Semiconductors**

## PEMD3; PIMD3; PUMD3

NPN/PNP resistor-equipped transistors



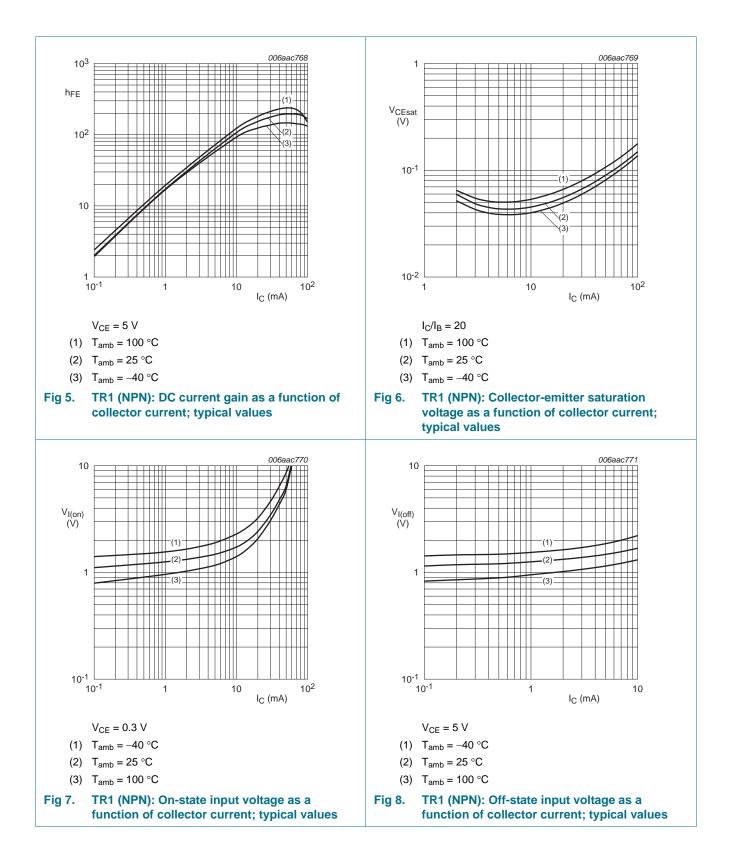
NPN/PNP resistor-equipped transistors

### 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per trans	istor; for the PNP tran	sistor (TR2) with negative p	olarity			
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
I <sub>CEO</sub>	collector-emitter	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$	-	-	1	μA
	cut-off current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	5	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 V; I_{C} = 0 A$	-	-	400	μA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 5 \text{ mA}$	30	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	-	150	mV
V <sub>I(off)</sub>	off-state input voltage	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 100 \mu\text{A}$	-	1.1	0.8	V
V <sub>I(on)</sub>	on-state input voltage	$V_{CE}$ = 0.3 V; I <sub>C</sub> = 10 mA	2.5	1.8	-	V
R1	bias resistor 1 (input)		7	10	13	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	
C <sub>c</sub>	collector capacitance	$\label{eq:VCB} \begin{split} V_{CB} &= 10 \text{ V};  \text{I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ \text{f} &= 1 \text{ MHz} \end{split}$				
	TR1 (NPN)		-	-	2.5	pF
	TR2 (PNP)		-	-	3	pF
f <sub>T</sub>	transition frequency	$V_{CB} = 5 \text{ V}; \text{ I}_{C} = 10 \text{ mA};$ f = 100 MHz	[1]			
	TR1 (NPN)		-	230	-	MHz
	TR2 (PNP)		-	180	-	MHz

[1] Characteristics of built-in transistor.

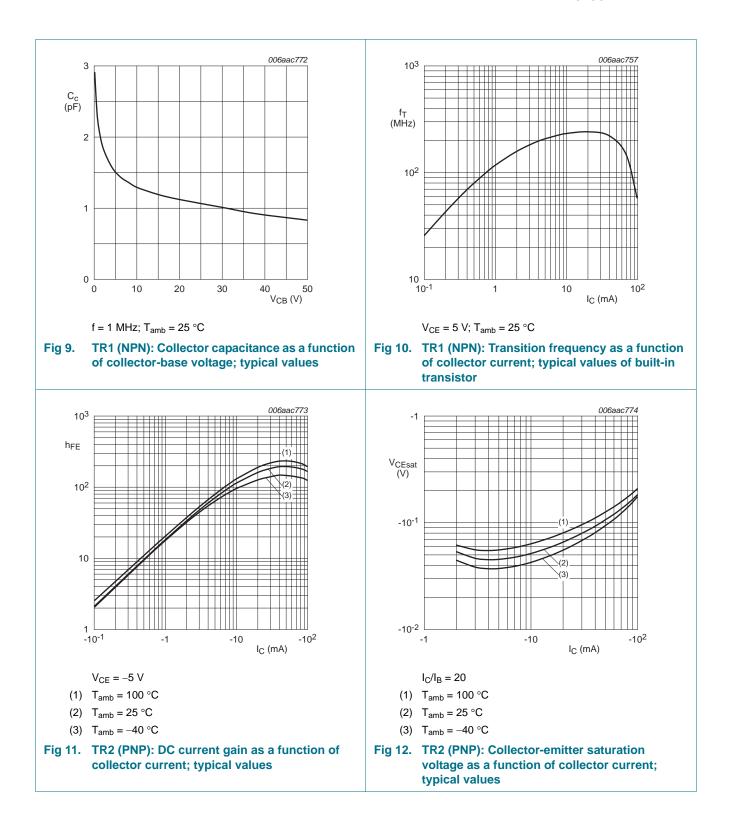
#### NPN/PNP resistor-equipped transistors



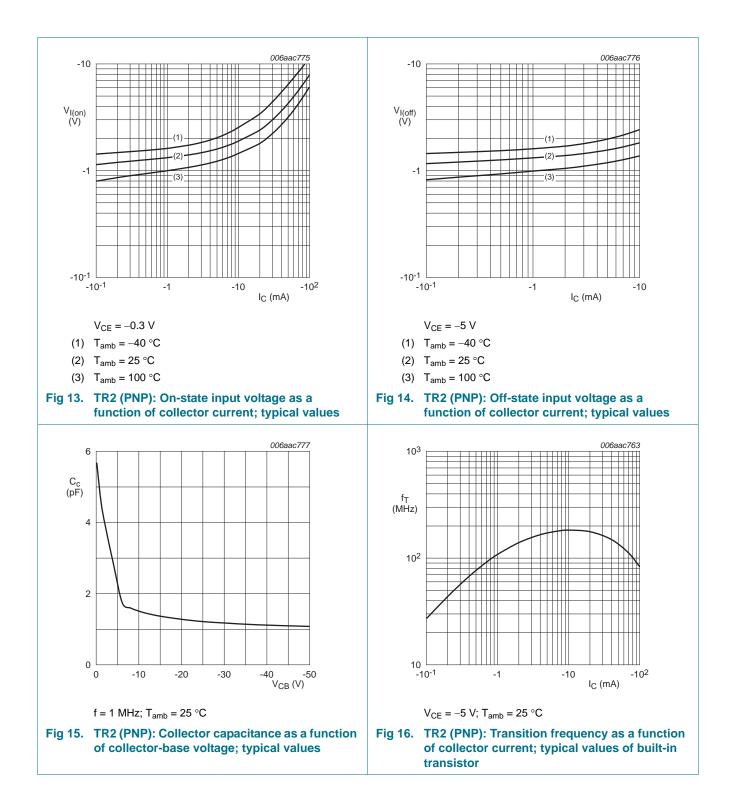
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## PEMD3; PIMD3; PUMD3

NPN/PNP resistor-equipped transistors



NPN/PNP resistor-equipped transistors



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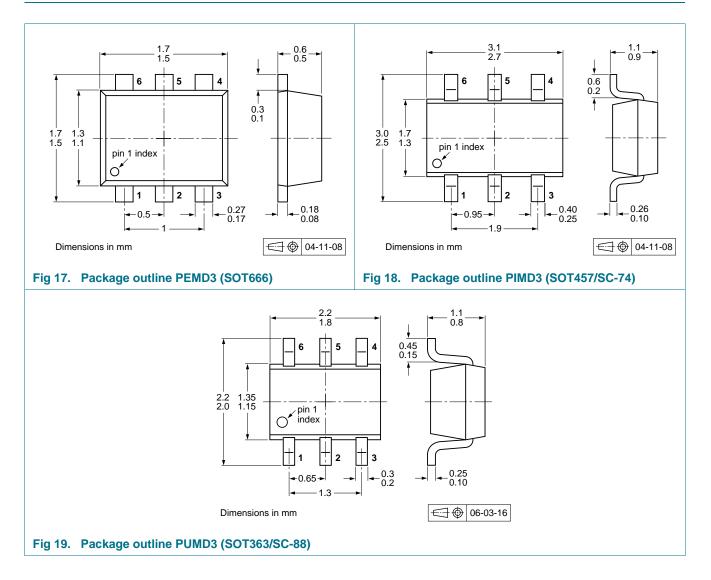
NPN/PNP resistor-equipped transistors

### 8. Test information

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

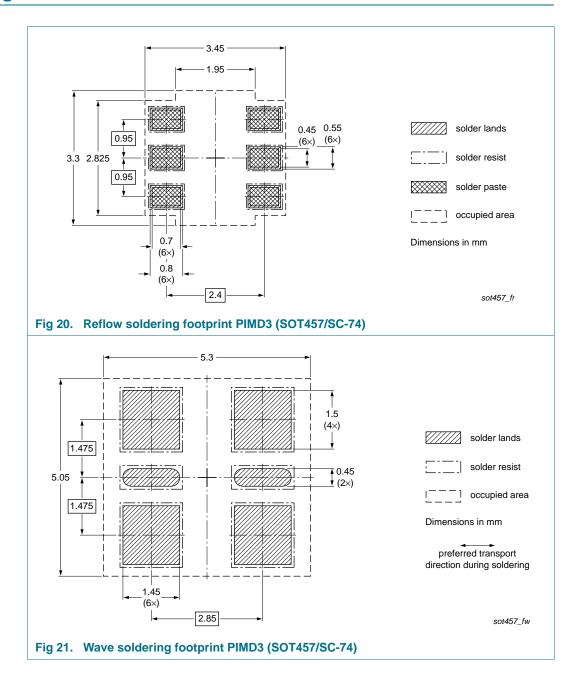
### 9. Package outline



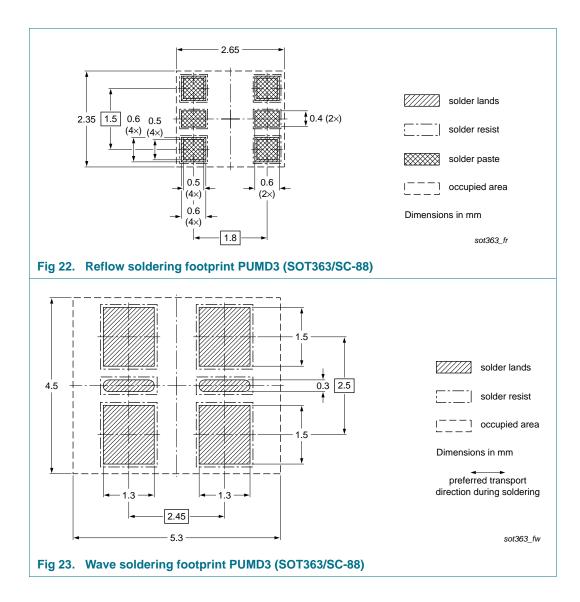
PEMD3\_PIMD3\_PUMD3

NPN/PNP resistor-equipped transistors

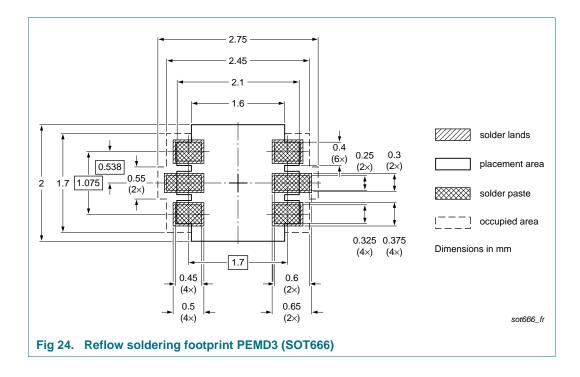
### **10. Soldering**



NPN/PNP resistor-equipped transistors



**NPN/PNP** resistor-equipped transistors



### NPN/PNP resistor-equipped transistors

### **11. Revision history**

Table 9. Rev	vision history								
Document ID		Release date	Data sheet status	Change notice	Supersedes				
PEMD3_PIMD3 PUMD3 v.11	3_	20130925	Product data sheet	-	PEMD3_PIMD3_ PUMD3 v.10				
Modifications:	Modifications:		roduct profile": updated						
		<ul> <li><u>Section 4 "Marking"</u>: updated</li> </ul>							
		<ul> <li><u>Table 6 "Limiting values</u>": P<sub>tot</sub> updated according to the latest measurements</li> </ul>							
		• Table 7 "The	rmal characteristics": upda	ated according to th	ne latest measurements				
		• Table 8 "Characteristics": I <sub>CEO</sub> updated according to the latest measurements, f <sub>T</sub> added							
			• Figure 1 to 3, 9, 10, 15 and 16: added						
		<ul> <li>Figure 5 to 8 and Figure 11 to 14: updated</li> </ul>							
		Section 8 "Te	est information": added						
		Section 10 "	Soldering": added						
		Section 12 "I	Legal information": update	ed					
PEMD3_PIMD3 PUMD3 v.10	3_	20091115	Product data sheet	-	PEMD3_PIMD3_ PUMD3 v.9				
PEMD3_PIMD3	3_ PUMD3 v.9	20050518	Product data sheet	-	PEMD3_PIMD3_ PUMD3 v.8				
	3 PUMD3 v.8	20041206	Product data sheet	-	PEMD3 PUMD3 v.7				

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### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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Date of release: 25 September 2013 Document identifier: PEMD3\_PIMD3\_PUMD3

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